

Form PTO-1595 (Rev. 08/08)
OMB No. 0651-0027 (exp. 9/30/2008)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Pavan Ramachandravithal Kashyap

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) 10/15/08

- ☐ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☒ Other Response to Notice of Non-Recordation

2. Name and address of receiving party(ies)

Name: Honeywell International Inc.

Internal Address: _____

Street Address: 101 Columbia Road

P.O. Box 2245

City: Morristown

State: New Jersey

Country: USA

Zip: 07962

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☐ This document is being filed together with a new application.

A. Patent Application No.(s)

12/260,261

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Honeywell International Inc.

Internal Address: _____

Street Address: 101 Columbia Road

P.O. Box 2245

City: Morristown

State: New Jersey

Zip: 07962

Phone Number: (602) 313-3345

Fax Number: (602) 313-4559

Email Address: docketing@olpatentlaw.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ _____

- ☐ Authorized to be charged to deposit account
☐ Enclosed
☒ None required (government interest not affecting title)

8. Payment Information

Deposit Account Number _____

Authorized User Name _____

9. Signature:

Kermit Lopez
Signature

11/5/2008
Date

Kermit Lopez

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 6

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1460, Alexandria, V.A. 22313-1450

USPTO

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FAX DELIVER

O:HONEYWELL INTERNATIONAL INC. COMPANY:101 COLUMBIA ROAD

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

10/29/2008
500689651

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Pavan Ramachandravithal Kashyap	10/15/2008
RECEIVING PARTY DATA	
Name:	Honeywell International Inc.
Street Address:	101 Columbia Road
Internal Address:	P.O. Box 2245
City:	Morristown
State/Country:	NEW JERSEY
Postal Code:	07962
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12260261
CORRESPONDENCE DATA	
Fax Number:	(602)313-4559
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	6023133345
Email:	docketing@olpatentlaw.com
Correspondent Name:	Honeywell International Inc.
Address Line 1:	101 Columbia Road
Address Line 2:	P.O. Box 2245
Address Line 4:	Morristown, NEW JERSEY 07962
ATTORNEY DOCKET NUMBER:	H0018706-0769
NAME OF SUBMITTER:	Luis M. Ortiz
Total Attachments: 1 source=H0018706_Assignment_signed#page1.tif	

CH 12260261 \$40.00

PATENT APPLICATION
Honeywell Docket No. H0018706-0769

ASSIGNMENT

WHEREAS, I, **Pavan Ramachandraviththal Kashyap**, of the City of Bangalore, Country of the Republic of India, have invented certain new and useful Improvements in **METHOD AND SYSTEM FOR PACKAGING AND MOUNTING SURFACE ACOUSTIC WAVE SENSOR ELEMENTS TO A FLEX PLATE**, for which an application is being made for Letters Patent of the United States.

Whereas, Honeywell International Inc., a corporation organized and existing under the laws of the State of Delaware, and having its principal offices at 101 Columbia Road, POB 2245, Morristown, New Jersey, U.S.A., 07962, is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor;

Now, therefore, for good and valuable consideration to us paid by the said Honeywell International Inc., the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Honeywell International Inc., its successors and assigns, my entire right, title and interest in and to said invention, said application and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights under any and all international conventions, treaties and/or agreements concerning patents to which the United States is a party, and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned assignee in accordance herewith.

I further authorize said assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of any international convention, treaty and/or agreement.

I do hereby covenant and agree with the said assignee, its successors and assigns, that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I or my executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said assignee, its successors and assigns, execute such additional writings and do such additional acts as said assignee, its successors and assigns, may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or any of and all foreign countries on said invention, and in enforcing any rights, occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

Full name of Sole Inventor: **Pavan Ramachandraviththal Kashyap**
Inventor's Signature: *Pavan R Kashyap*
Date: *15 / October / 2008*
Residence (City, State): **Bangalore, Karnataka, India**
Post Office Address **Flat 10, Garuthman Apartments, 17th A Cross**
8th Main, Malleswaram
Bangalore, Karnataka, 560055, India
Citizenship: **REPUBLIC OF INDIA**

O: HONEYWELL INTERNATIONAL INC. COMPANY: 101 COLUMBIA ROAD

PATENT APPLICATION
Honeywell Docket No. H0018706-0769

ASSIGNMENT

WHEREAS, I, Pavan Ramachandravithal Kashyap, of the City of Bangalore, Country of the Republic of India, have invented certain new and useful improvements in **METHOD AND SYSTEM FOR PACKAGING AND MOUNTING SURFACE ACOUSTIC WAVE SENSOR ELEMENTS TO A FLEX PLATE**, for which an application is being made for Letters Patent of the United States,

Whereas, Honeywell International Inc., a corporation organized and existing under the laws of the State of Delaware, and having its principal offices at 101 Columbia Road, POB 2245, Morristown, New Jersey, U.S.A., 07962, is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor;

Now, therefore, for good and valuable consideration to us paid by the said Honeywell International Inc., the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Honeywell International Inc., its successors and assigns, my entire right, title and interest in and to said invention, said application and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights under any and all International conventions, treaties and/or agreements concerning patents to which the United States is a party, and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned assignee in accordance herewith.

I further authorize said assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of any International convention, treaty and/or agreement.

I do hereby covenant and agree with the said assignee, its successors and assigns, that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I or my executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said assignee, its successors and assigns, execute such additional writings and do such additional acts as said assignee, its successors and assigns, may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or any of and all foreign countries on said invention, and in enforcing any rights, occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

Full name of Sole Inventor: Pavan Ramachandravithal Kashyap
Inventor's Signature: *Pavan R Kashyap*
Date: *15 / October / 2008*
Residence (City, State): Bangalore, Karnataka, India
Post Office Address: Flat 10, Garuthman Apartments, 17th A Cross
8th Main, Malleswaram
Bangalore, Karnataka, 560055, India
Citizenship: REPUBLIC OF INDIA

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